imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



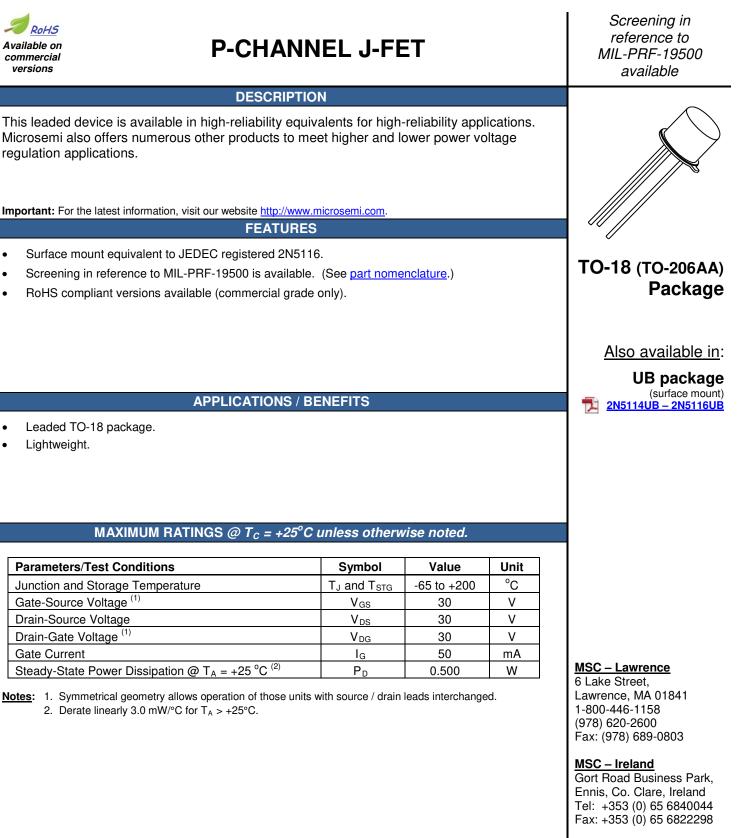
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Website:

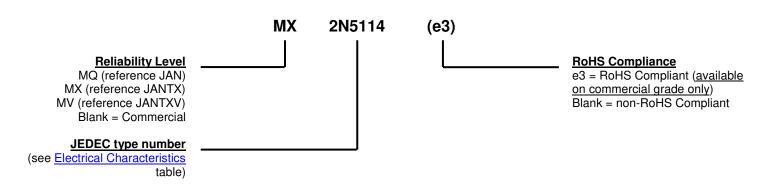
www.microsemi.com



MECHANICAL and PACKAGING

- CASE: Hermetically sealed, Nickel plated Kovar Base, Nickel Cap.
- TERMINALS: Gold plate over nickel, Kovar, Solder dipped. RoHS compliant Matte/Tin plating available on commercial grade only.
- MARKING: Part Number, Data Code, Manufacturer's ID.
- WEIGHT: Approximately 0.3 grams.
- See <u>Package Dimensions</u> on last page.

PART NOMENCLATURE





ELECTRICAL CHARACTERISTICS @ $T_A = +25^{\circ}C$ unless otherwise noted.

Parameters / Test Conditions		Symbol	Min.	Max.	Unit
Gate-Source Breakdown Voltage $V_{DS} = 0, I_G = 1.0 \ \mu A$		V _{(BR)GSS}	30		V
$\label{eq:GS} \begin{array}{l} \text{Drain-Source "On" State Voltage} \\ \text{V}_{\text{GS}} = 0 \ \text{V}, \ \text{I}_{\text{D}} = -15 \ \text{mA} \\ \text{V}_{\text{GS}} = 0 \ \text{V}, \ \text{I}_{\text{D}} = -7.0 \ \text{mA} \\ \text{V}_{\text{GS}} = 0 \ \text{V}, \ \text{I}_{\text{D}} = -3.0 \ \text{mA} \end{array}$	2N5114 2N5115 2N5116	V _{DS(on)}		-1.3 -0.8 -0.6	V
Gate Reverse Current $V_{DS} = 0, V_{GS} = 20 V$		I _{GSS}		500	pА
	2N5114 2N5115 2N5116	I _{D(off)}		-500 -500 -500	pА
Zero Gate Voltage Drain Current $V_{GS} = 0$, $V_{DS} = -18V$ $V_{GS} = 0$, $V_{DS} = -15V$ $V_{GS} = 0$, $V_{DS} = -15V$	2N5114 2N5115 2N5116	I _{DSS}	-30 -15 -5.0	-90 -60 -25	mA
Gate-Source Cutoff $V_{DS} = -15$, $I_D = -1.0$ nA $V_{DS} = -15$, $I_D = -1.0$ nA $V_{DS} = -15$, $I_D = -1.0$ nA	2N5114 2N5115 2N5116	V _{GS(off)}	5.0 3.0 1.0	10 6.0 4.0	V

DYNAMIC CHARACTERISTICS

Parameters / Test Conditions		Symbol	Min.	Max.	Unit
Small-Signal Drain-Source "On" State Resistance					
$V_{GS} = 0, I_{D} = -1.0 \text{ mA}$	2N5114 2N5115 2N5116	r _{ds(on)1}		75 100 175	Ω
Small-Signal Drain-Source "On" State Res					
$V_{GS} = 0, I_{D} = 0; f = 1 \text{ kHz}$	2N5114 2N5115 2N5116	r _{ds(on)2}		75 100 175	Ω
Small-Signal, Common-Source Short-Circuit Reverse Transfer Capacitance					
	2N5114 2N5115 2N5116	C _{rss}		7.0	pF
Small-Signal, Common-Source Short-Circu $V_{GS} = 0$, $V_{DS} = -15$ V, f = 1.0 MHz	uit Input Capacitance 2N5114, 2N5115 2N5116	C _{iss}		25 27	pF



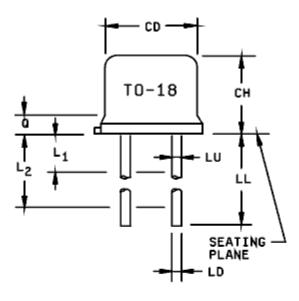
ELECTRICAL CHARACTERISTICS $@T_A = +25^{\circ}C$ unless otherwise noted. (continued)

SWITCHING CHARACTERISTICS						
Parameters / Test Conditions		Symbol	Min.	Max.	Unit	
Turn-On Delay Time	2N5114 2N5115 2N5116	T _{d(on)}		6 10 25	ηs	
Rise Time	2N5114 2N5115 2N5116	tr		10 20 35	ηs	
Turn-Off Delay Time	2N5114 2N5115 2N5116	T _{d(off)}		6 8 20	ηs	

T4-LDS-0006, Rev. 2 (111983)

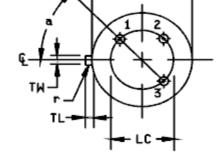


PACKAGE DIMENSIONS



HD

	Dimensions					
Symbol	Inches		Millimeters		Note	
	Min	Max	Min	Max		
CD	.178	.195	4.52	4.95		
CH	.170	.210	4.32	5.33		
HD	.209	.230	5.31	5.84		
LC	.100	.100 TP		2.54 TP		
LD	.016	.021	0.41	0.53	7,8	
LL	.500	.750	12.70	19.05	7,8	
LU	.016	.019	0.41	0.48	7,8	
L1		.050		1.27	7,8	
L2	.250		6.35		7,8	
Q		.030		0.76	5	
TL	.028	.048	0.71	1.22	3,4	
TW	.036	.046	0.91	1.17		
r		.010		0.25	10	
α	45° TP		45° TP		6	
1, 2, 9, 11, 12						



NOTES:

- 1. Dimension are in inches.
- 2. Millimeters are given for general information only.
- 3. Beyond r (radius) maximum, TH shall be held for a minimum length of .011 inch (0.28 mm).
- 4. Dimension TL measured from maximum HD.
- 5. Body contour optional within zone defined by HD, CD, and Q.
- Leads at gauge plane .054 +.001 -.000 inch (1.37 +0.03 -0.00 mm) below seating plane shall be within .007 inch (0.18 mm) radius of true position (TP) at maximum material condition (MMC) relative to tab at MMC. The device may be measured by direct methods or by the gauge and gauging procedure shown in figure 2.
- 7. Dimension LU applies between L₁ and L₂. Dimension LD applies between L₂ and LL minimum. Diameter is uncontrolled in L₁ and beyond LL minimum.
- 8. All three leads.
- 9. The collector shall be internally connected to the case.
- 10. Dimension r (radius) applies to both inside corners of tab.
- 11. In accordance with ASME Y14.5M, diameters are equivalent to ϕx symbology.
- 12. Lead 1 =source, lead 2 =gate, lead 3 =drain.